



## SUPER-MOSFET

Super Junction Metal Oxide Semiconductor Field Effect Transistor

650V Super Junction Power MOSFET Gen-**II** With Fast-Recovery  
SS\*65R099SFD

Rev. 2.0  
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# SSF65R099SFD/SSW65R099SFD

## 650V N-Channel Super-Junction MOSFET Gen-II

### With Fast-Recovery

#### Description

SJ-FET is new generation of high voltage MOSFET family that is utilizing an advanced charge balance mechanism for outstanding low on-resistance and lower gate charge performance. This advanced technology has been tailored to minimize conduction loss, provide superior switching performance, and withstand extreme dv/dt rate and higher avalanche energy. SJ-FET is suitable for various AC/DC power conversion in switching mode operation for higher efficiency.

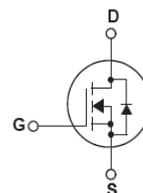
#### Features

- Multi-Epi process SJ-FET
- Fast-Recovery body diode
- Extremely Low Reverse Recovery Charge
- 700V @T<sub>J</sub> = 150 °C
- Typ. R<sub>DS(on)</sub> = 0.085Ω
- Ultra Low Gate Charge (typ. Q<sub>g</sub> = 75nC)
- 100% avalanche tested

SSF65R099SFD



SSW65R099SFD



#### Absolute Maximum Ratings

Symbol	Parameter	SSF65R099SFD	SSW65R099SFD	Unit
V <sub>DSS</sub>	Drain-Source Voltage		650	V
I <sub>D</sub>	Drain Current -Continuous (TC = 25°C) -Continuous (TC = 100°C)		40* 25*	A
I <sub>DM</sub>	Drain Current - Pulsed (Note 1)		140	A
V <sub>GSS</sub>	Gate-Source voltage		±30	V
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 2)		1160	mJ
I <sub>AS</sub>	Avalanche current, repetitive or not-repetitive (pulse width limited by T <sub>J</sub> max)		9	A
dv/dt	Peak Diode Recovery dv/dt (Note 3)		50	V/ns
dVds/dt	Drain Source voltage slope (V <sub>ds</sub> =480V)		50	V/ns
P <sub>D</sub>	Power Dissipation (TC = 25°C)	37	300	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to +150		°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering Purpose, 1/16" from Case for 10 Seconds	260		°C

\* Drain current limited by maximum junction temperature. Maximum duty cycle D=0.75.

#### Thermal Characteristics

Symbol	Parameter	SSF65R099SFD	SSW65R099SFD	Unit
R <sub>θJC</sub>	Thermal Resistance, Junction-to-Case	3.4	0.42	°C/W
R <sub>θCS</sub>	Thermal Resistance, Case-to-Sink Typ.	-	0.5	°C/W
R <sub>θJA</sub>	Thermal Resistance, Junction-to-Ambient	80	62	°C/W



# Electrical Characteristics TC = 25°C unless otherwise noted

SSF65R099SFD/SSW65R099SFD 650V N-Channel Super-Junction MOSFET Gen-II With Fast-Recovery

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Off Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 25°C	650	-	-	V
		V <sub>GS</sub> = 0V, I <sub>D</sub> = 250μA, T <sub>J</sub> = 150°C	700	-	-	V
ΔBV <sub>DSS</sub> /ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	I <sub>D</sub> = 250μA, Referenced to 25°C	-	0.6	-	V/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 650V, V <sub>GS</sub> = 0V -T <sub>C</sub> = 125°C	-	- 300	5 -	μA μA
I <sub>GSSF</sub>	Gate-Body Leakage Current, Forward	V <sub>GS</sub> = 30V, V <sub>DS</sub> = 0V	-	-	100	nA
I <sub>GSSR</sub>	Gate-Body Leakage Current, Reverse	V <sub>GS</sub> = -30V, V <sub>DS</sub> = 0V	-	-	-100	nA
<b>On Characteristics</b>						
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250μA	3.0	4.0	5.0	V
R <sub>DS(on)</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 20A	-	0.085	0.099	Ω
<b>Dynamic Characteristics</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 100V, V <sub>GS</sub> = 0V, f = 1.0MHz	-	3600	-	pF
C <sub>oss</sub>	Output Capacitance		-	105	-	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		-	3	-	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> = 400V, I <sub>D</sub> = 40A, V <sub>GS</sub> = 10V (Note 4)	-	75	-	nC
Q <sub>gs</sub>	Gate-Source Charge		-	24	-	nC
Q <sub>gd</sub>	Gate-Drain Charge		-	30	-	nC
R <sub>g</sub>	Gate resistance	f=1 MHz, open drain	-	0.8	-	Ω
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DS</sub> = 400V, I <sub>D</sub> = 40A R <sub>G</sub> = 25Ω, V <sub>GS</sub> = 10V (Note 4)	-	50	-	ns
t <sub>r</sub>	Turn-On Rise Time		-	120	-	ns
t <sub>d(off)</sub>	Turn-Off Delay Time		-	105	-	ns
t <sub>f</sub>	Turn-Off Fall Time		-	50	-	ns
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
I <sub>S</sub>	Maximum Continuous Drain-Source Diode Forward Current		-	-	40	A
I <sub>SM</sub>	Maximum Pulsed Drain-Source Diode Forward Current		-	-	140	A
V <sub>SD</sub>	Drain-Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>S</sub> = 20A	-	0.9	1.4	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, V <sub>DS</sub> = 400V, I <sub>S</sub> = 20A, diF/dt = 100A/μs	-	150	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge		-	0.87	-	μC
I <sub>rrm</sub>	Peak Reverse Recovery Current		-	12	-	A

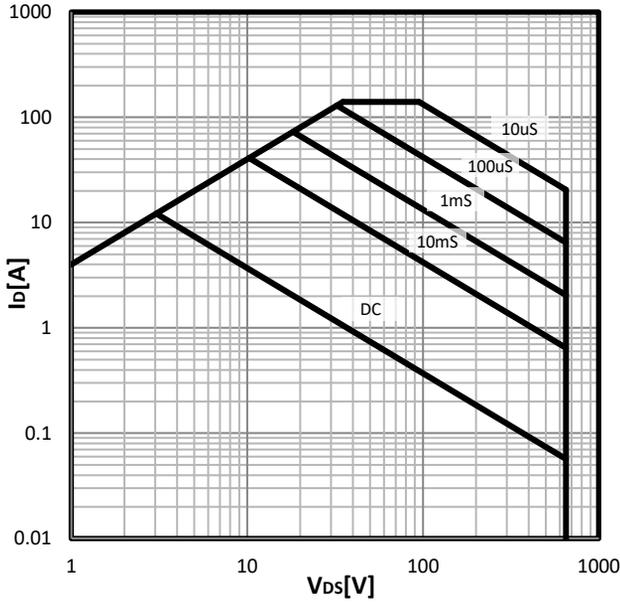
**NOTES:**

1. Repetitive Rating: Pulse width limited by maximum junction temperature
2. I<sub>D</sub> = I<sub>AS</sub>, V<sub>DD</sub> = 50V, Starting T<sub>J</sub> = 25 °C
3. I<sub>SD</sub> ≤ I<sub>D</sub>, di/dt ≤ 200A/μs, V<sub>DD</sub> ≤ BV<sub>DSS</sub>, Starting T<sub>J</sub> = 25 °C
4. Essentially Independent of Operating Temperature Typical Characteristics

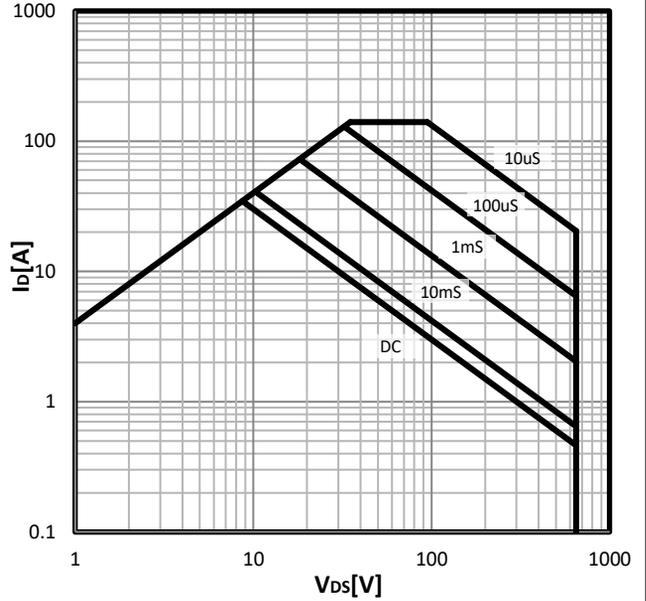


# Typical Performance Characteristics

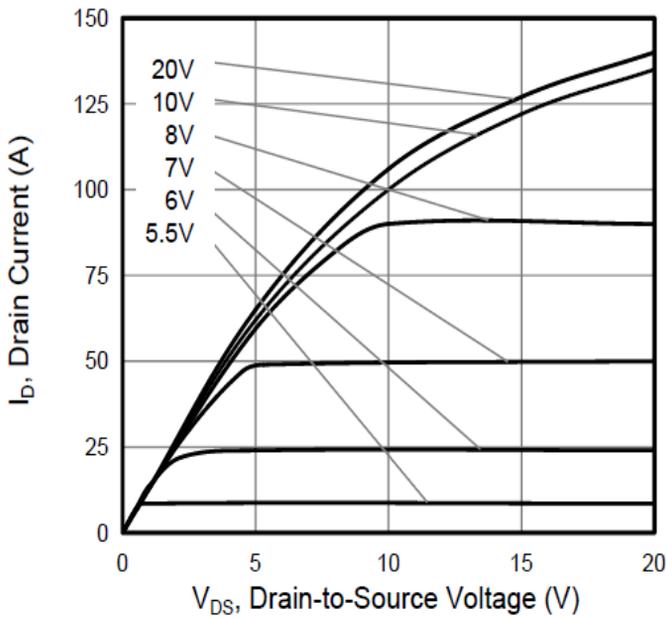
Safe operating area  $T_C=25\text{ }^\circ\text{C}$   
parameter: tp; TO-220F



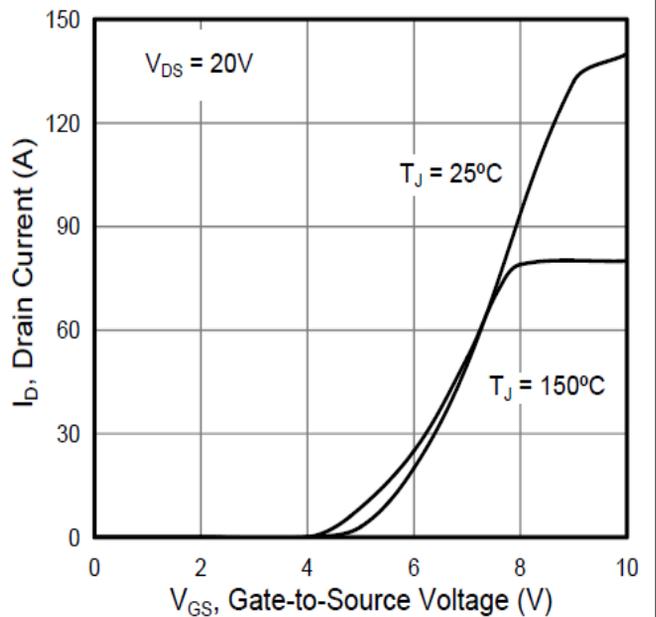
Safe operating area  $T_C=25\text{ }^\circ\text{C}$   
parameter: tp; TO-247



Typ. output characteristics  $T_J=25\text{ }^\circ\text{C}$   
parameter:  $V_{GS}$



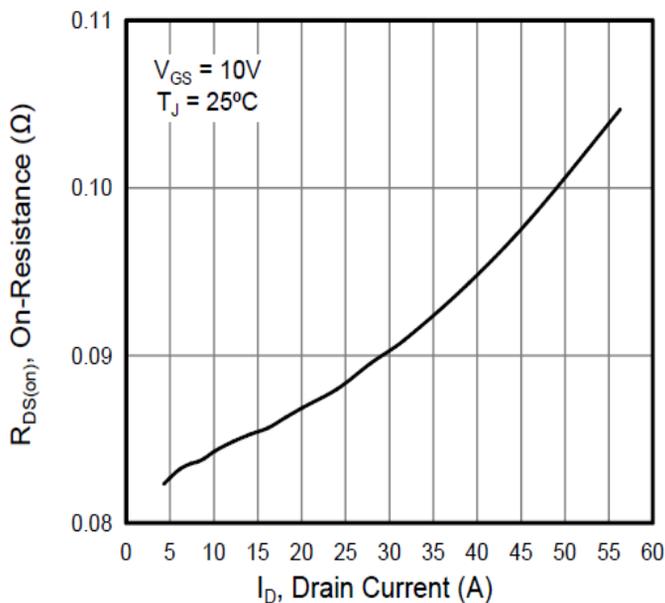
Typ. transfer characteristics



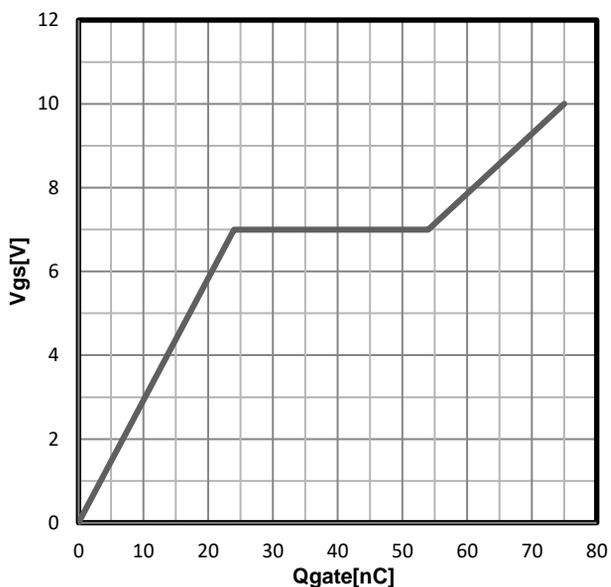


# Typical Performance Characteristics

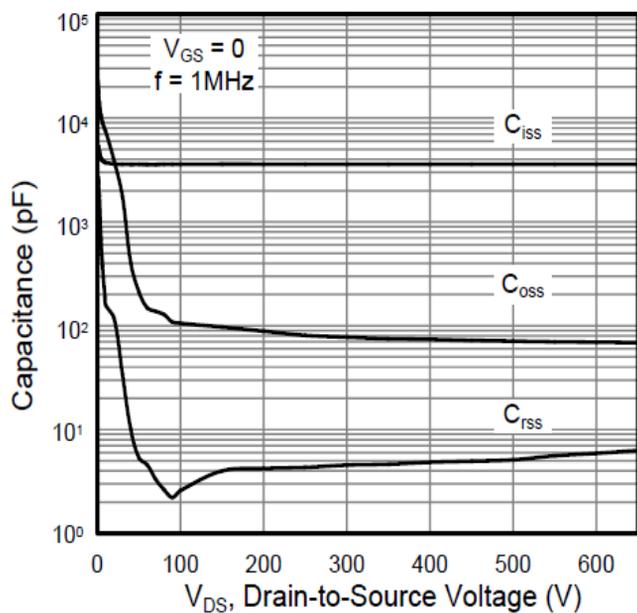
Typ. drain-source on-state resistance parameter:  $V_{GS}$  &  $I_D$



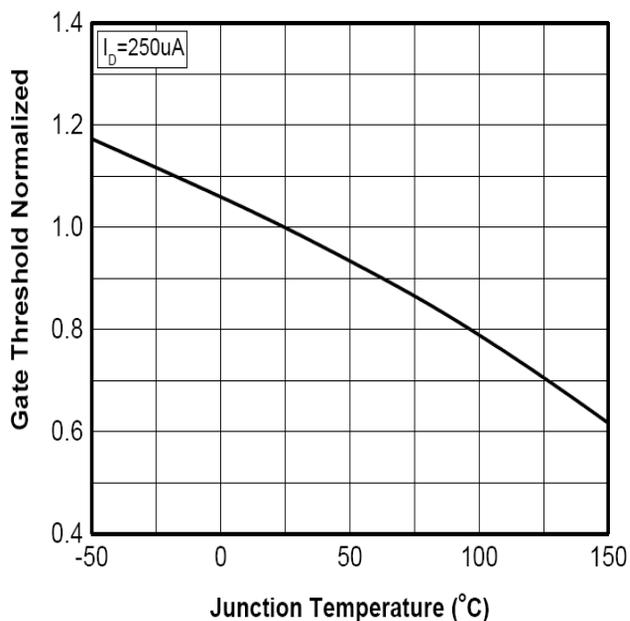
Typ. gate charge characteristics



Typ. capacitances



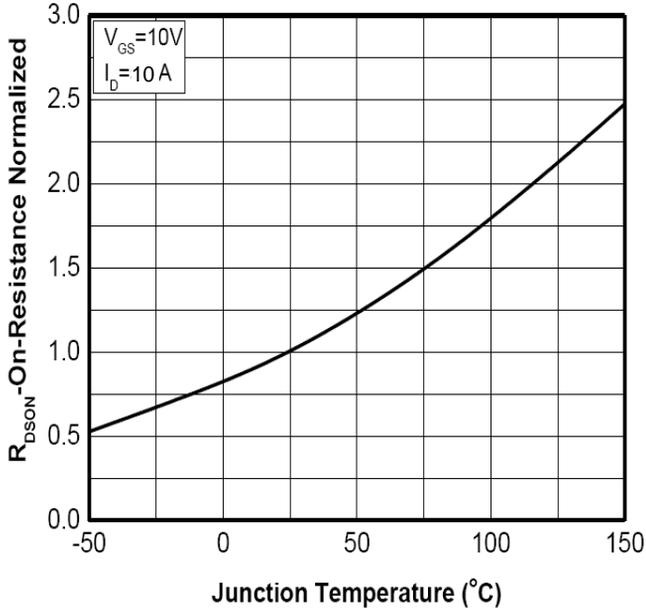
Normalized  $V_{GS(th)}$  characteristics



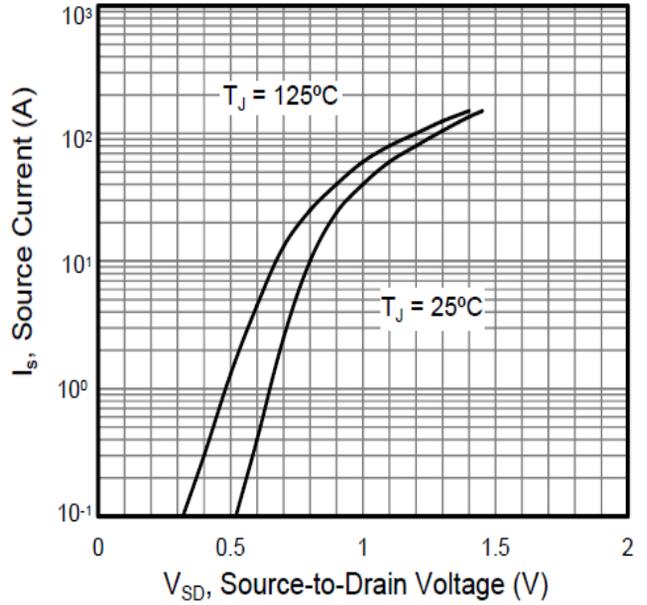


# Typical Performance Characteristics

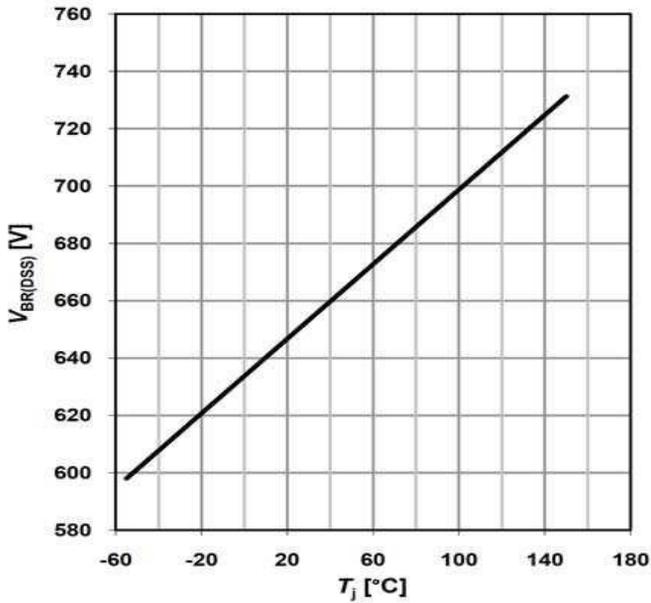
Normalized on-resistance vs temperature



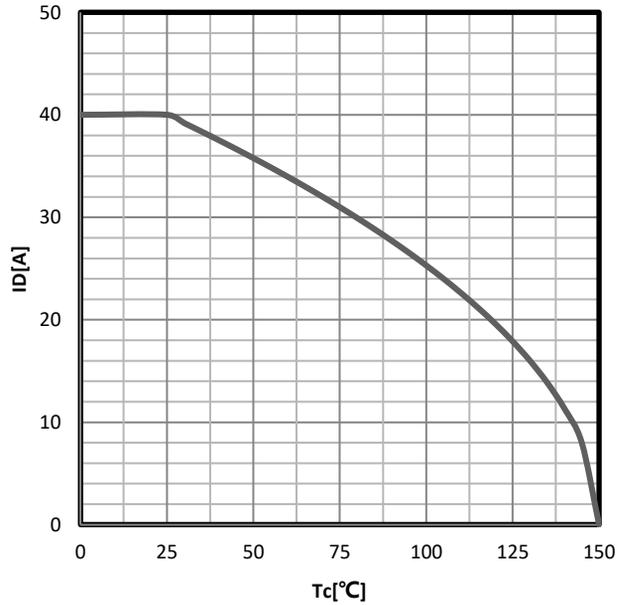
Forward characteristics of reverse diode



Drain-source breakdown voltage

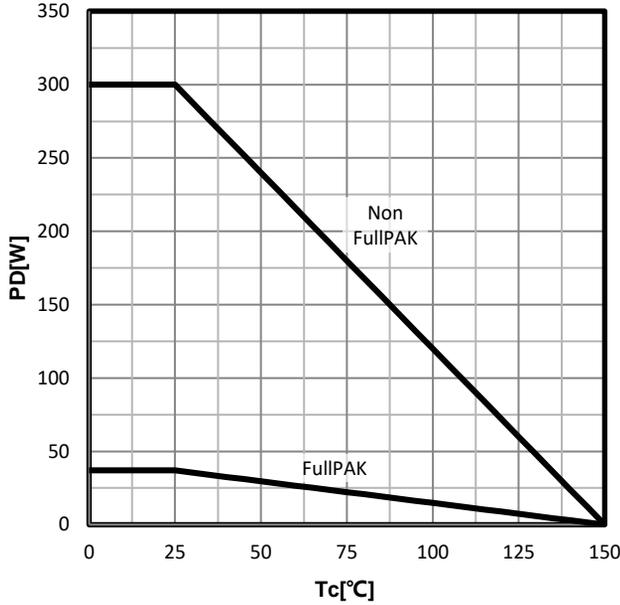


Max. drain current

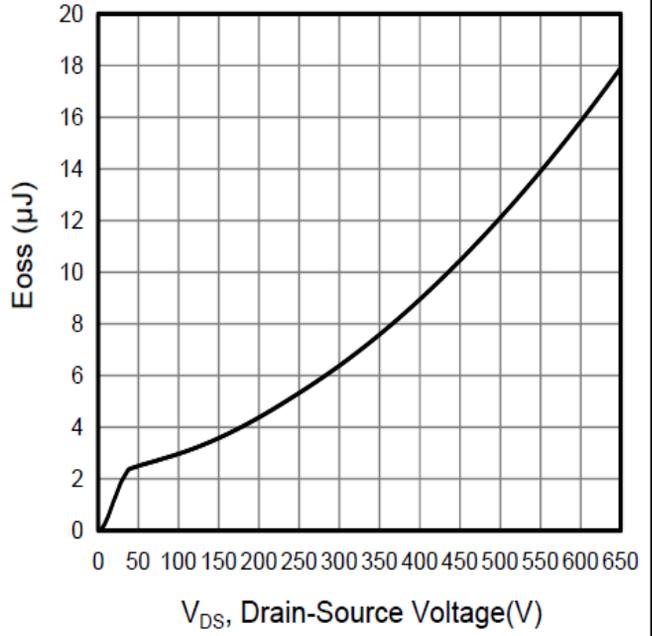


# Typical Performance Characteristics

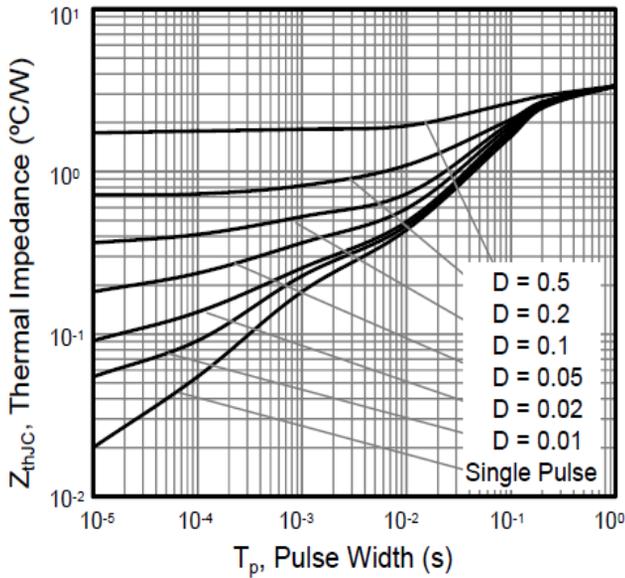
Power dissipation



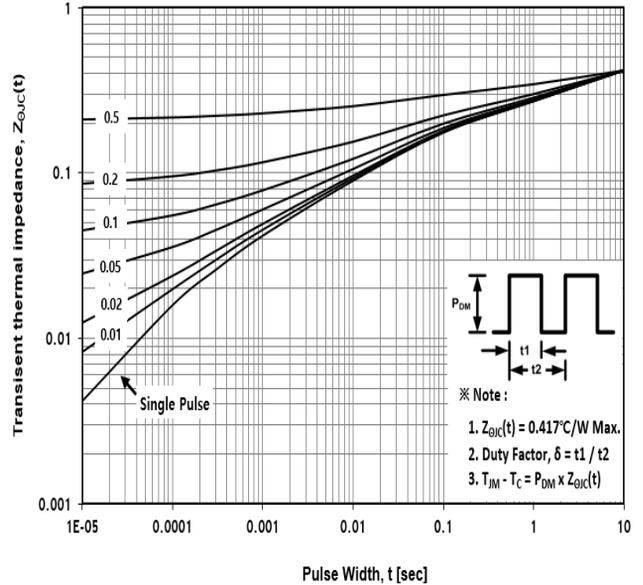
Coss stored energy



Max. transient thermal impedance parameter:  $D=tp/T$ ; TO-220F

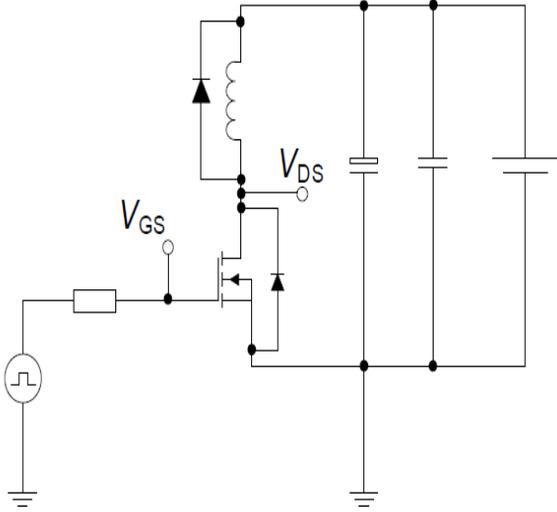


Max. transient thermal impedance parameter:  $D=tp/T$ ; TO-247

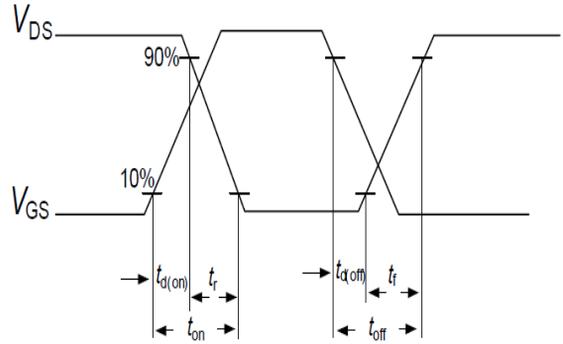


## Switching times test circuit and waveform for inductive load

Switching times test circuit for inductive load

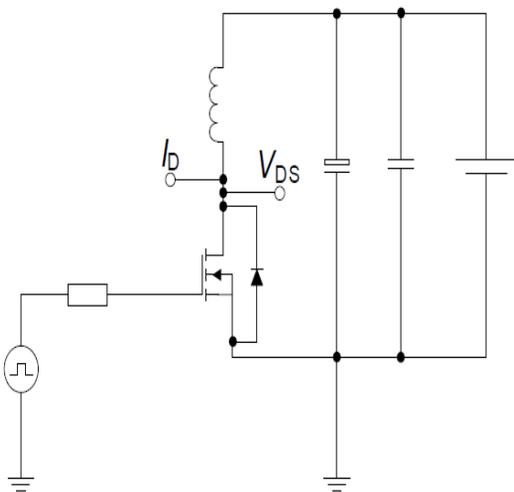


Switching time waveform

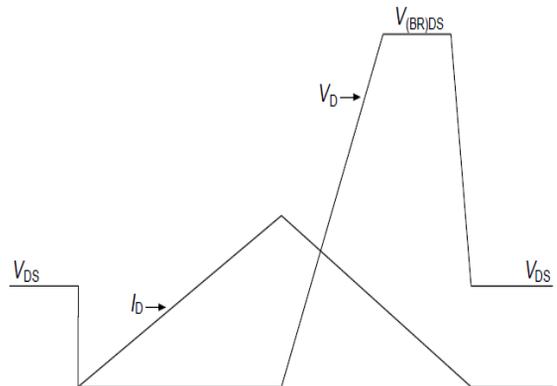


## Unclamped inductive load test circuit and waveform

Unclamped inductive load test circuit

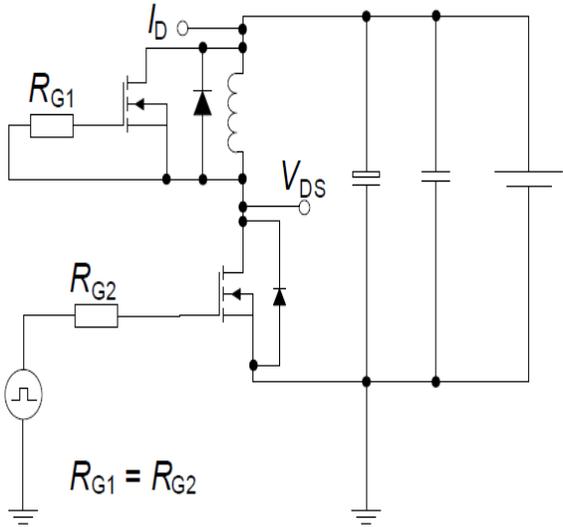


Unclamped inductive waveform

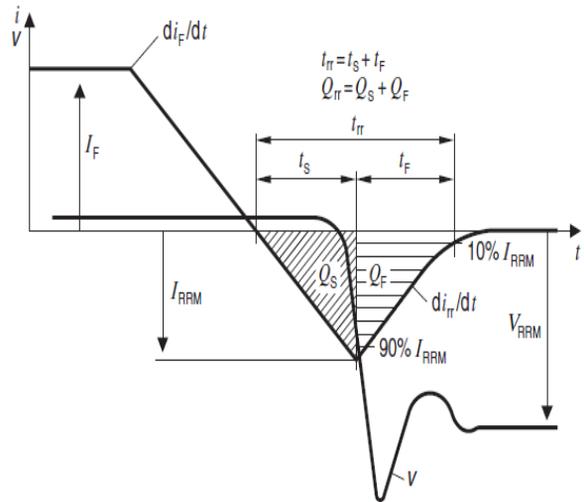


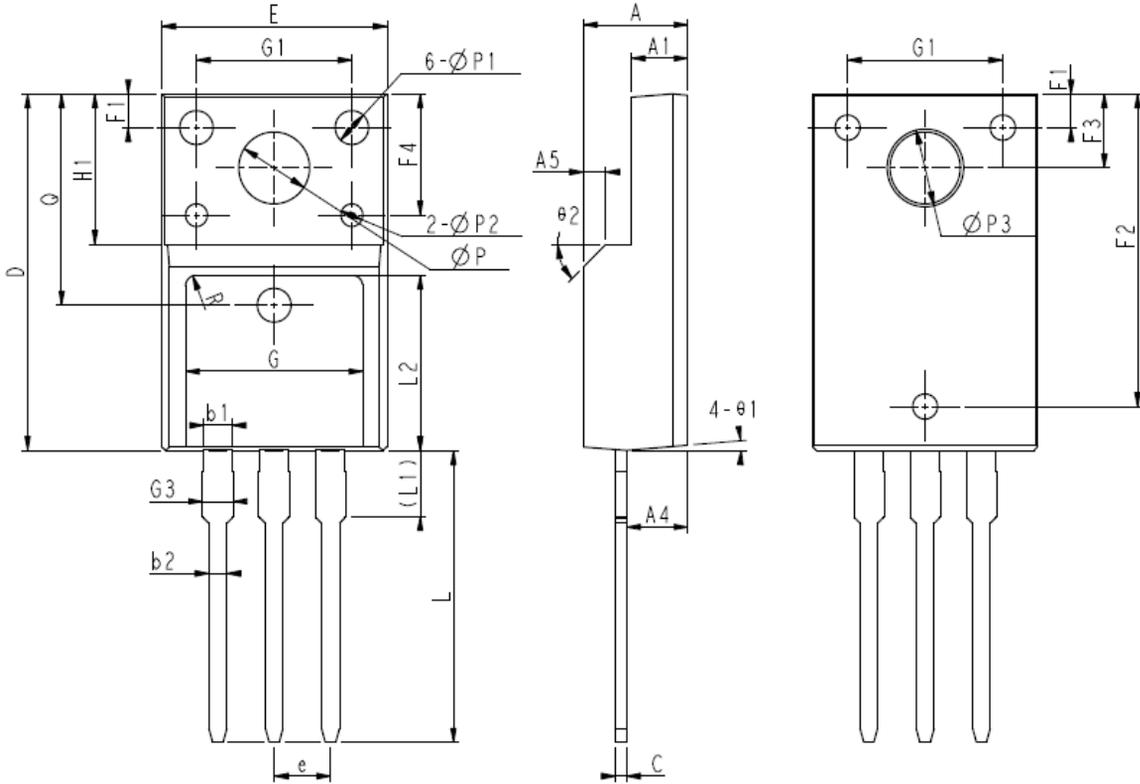
## Test circuit and waveform for diode characteristics

Test circuit for diode characteristics



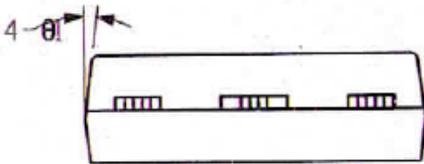
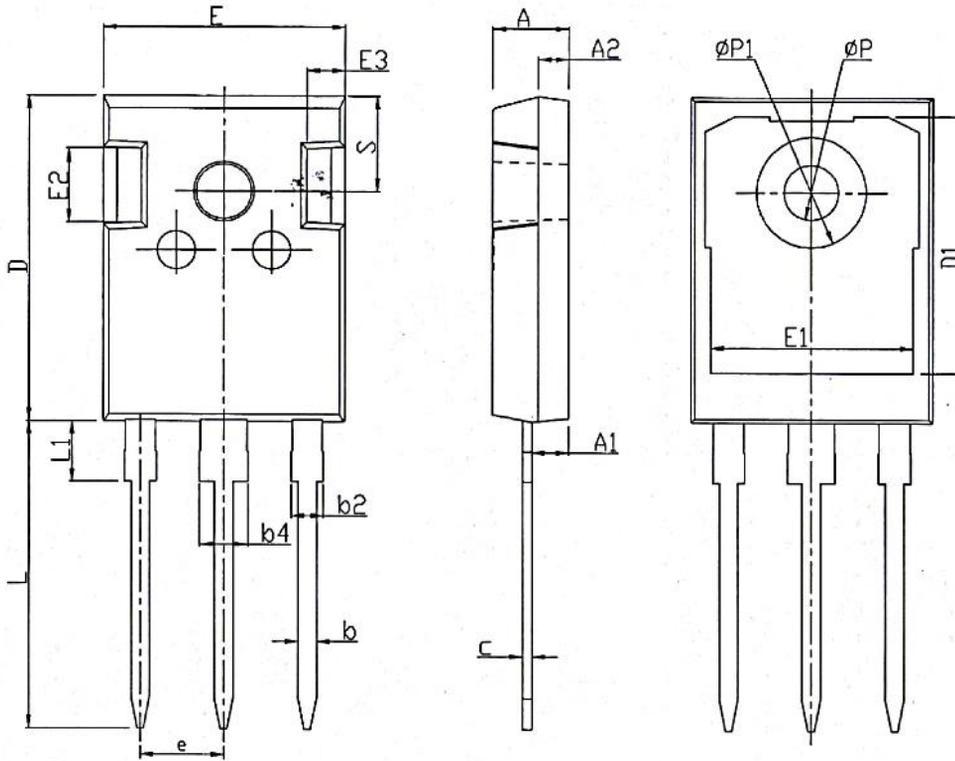
Diode recovery waveform





COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
E	10.00	10.16	10.32
E1	9.94	10.04	10.14
E2	9.36	9.46	9.56
A	4.50	4.70	4.90
A1	2.34	2.54	2.74
A4	2.66	2.76	2.86
A5	1.00REF		
c	0.45	0.50	0.60
D	15.67	15.87	16.07
Q	9.40REF		
H1	6.70REF		
e	2.54BSC		
ΦP	3.18REF		
L	12.78	12.98	13.18
L1	2.83	2.93	3.03
L2	7.70	7.80	7.90
ΦP1	1.40	1.50	1.60
ΦP2	0.95	1.00	1.05
ΦP3	3.45REF		
θ1	3°	5°	7°
θ2	-	45°	-
F1	1.00	1.50	2.00
F2	13.80	13.90	14.00
F3	3.20	3.30	3.40
F4	5.30	5.40	5.50
G	7.80	8.00	8.20
G1	6.90	7.00	7.10
G3	1.25	1.35	1.45
b1	1.23	1.28	1.38
b2	0.75	0.80	0.90
K1	0.65	0.70	0.75
R	0.50REF		



COMMON DIMENSIONS

SYMBOL	MM		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.21	2.41	2.61
A2	1.85	2.00	2.15
b	1.11	1.21	1.36
b2	1.91	2.01	2.21
b4	2.91	3.01	3.21
c	0.51	0.61	0.75
D	20.70	21.00	21.30
D1	16.25	16.55	16.85
E	15.50	15.80	16.10
E1	13.00	13.30	13.60
E2	4.80	5.00	5.20
E3	2.30	2.50	2.70
e	5.44BSC		
L	19.62	19.92	20.22
L1	-	-	4.30
ΦP	3.40	3.60	3.80
ΦP1	-	-	7.30
S	6.15BSC		



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